



INTEGRATED SILICON SOLUTION, INC.

## Process Change Notification

**Date:** May 14, 2020

**Change Notification No:** PCN2020-0021\_E

**From:** ISSI-Integrated Silicon Solution, Inc.

**To:** ISSI Current Customers

### ISSI Part Number Change:

Old Part Number	New Part Number
IS25LQ032B	IS25LP032D
IS25LQ016B	IS25LP016D

### Description of the Change:

Die shrink of 90nm process based 32Mb and 16Mb Serial NOR Flash to 65nm process. All of the old die revisions (90nm) and replacement die revisions (65nm) are from XMC China.

### Reason for the Change

The process migration is to ensure long term supply and to provide improved product performance and quality.

<b>Sample Date:</b>	Available Now
<b>Characterization &amp; Qualification Data:</b>	Available Now
<b>Old Part Number Last Order Date:</b>	December 31 <sup>st</sup> , 2020
<b>Old Part Number Last Ship Date:</b>	December 31 <sup>st</sup> , 2021
<b>Proposed Effective Date:</b>	January 1 <sup>st</sup> , 2022

Please contact marketing at [flash@issi.com](mailto:flash@issi.com) for further information.

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